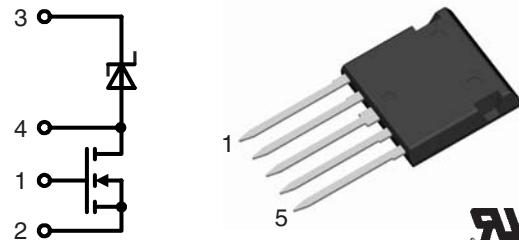


Boost Chopper

with Trench Power MOSFET
and Schottky Diode
in ISOPLUS i4-PAC™

I_{D25} = 100 A
V_{DSS} = 55 V
R_{DSon}(typ.) = 3.8 mΩ

Preliminary data



MOSFET

Symbol	Conditions	Maximum Ratings		
V _{DSS}	T _{VJ} = 25°C to 150°C	55	V	
V _{GS}		±20	V	
I _{D25}	T _C = 25°C	150	A	
I _{D90}	T _C = 90°C	110	A	

Symbol	Conditions	Characteristic Values		
		(T _{VJ} = 25°C, unless otherwise specified)	min.	typ.
R _{DSon}	V _{GS} = 10 V; I _D = I _{D90}		3.8	4.9 mΩ
V _{GSth}	V _{DS} = 20 V; I _D = 1 mA		2	4 V
I _{DSS}	V _{DS} = 55V; V _{GS} = 0 V; T _{VJ} = 25°C T _{VJ} = 125°C		0.1	1 μA mA
I _{GSS}	V _{GS} = ±20 V; V _{DS} = 0 V			0.2 μA
Q _g Q _{gs} Q _{gd}	{ V _{GS} = 10 V; V _{DS} = 44 V; I _D = 25 A		86 18 25	nC nC nC
t _{d(on)} t _r t _{d(off)} t _f	{ V _{GS} = 10 V; V _{DS} = 30 V; I _D = 25A; R _G = 10 Ω		25 50 70 40	ns ns ns ns
R _{thJC} R _{thJH}	with heat transfer paste		1.5	1 K/W K/W

Features

- trench MOSFET
 - very low on state resistance R_{DSon}
 - fast switching
- Schottky diode
 - low forward voltage
 - extremely fast switching
 - blocking capability optimized for elevated temperature
- ISOPLUS i4-PAC™ package
 - isolated back surface
 - low coupling capacity between pins and heatsink
 - enlarged creepage towards heatsink
 - application friendly pinout
 - low inductive current path
 - high reliability
 - industry standard outline
 - UL registered, E 72873

Applications

- automotive
 - choppers - replacing series resistors for DC drives, heating etc.
 - control of SR drives
 - DC-DC converters
 - electronic switches -replacing relays and fuses
- power supplies
 - DC-DC converters
 - solar inverters
- battery supplied systems
 - choppers for drives in hand held tools
 - battery chargers

Schottky Diode

Symbol	Conditions	Maximum Ratings		
V_{RRM}	$T_{VJ} = 25^\circ\text{C}$ to 150°C	45		V
I_{F25}	$T_c = 25^\circ\text{C}$	110		A
I_{F90}	$T_c = 90^\circ\text{C}$	75		A

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
V_F	$I_F = 40 \text{ A}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.7	0.9 V V
I_R	$V_R = V_{RRM}$; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		1	0.5 mA mA
R_{thJC} R_{thJH}	with heatsink compound		1.9	1.5 K/W K/W

Component

Symbol	Conditions	Maximum Ratings		
I_{RMS}	per pin		75	A
T_{VJ} T_{stg}		-55...+175 -55...+125		°C °C
V_{ISOL}	$I_{ISOL} \leq 1 \text{ mA}$; 50/60 Hz		2500	V~
F_c	mounting force with clip		20...120	N

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
C_p	coupling capacity between shorted pins and mounting tab in the case		40	pF
d_s, d_A	pin - pin	1.7		mm
d_s, d_A	pin - backside metal	5.5		mm
Weight			9	g

Dimensions in mm (1 mm = 0.0394")